



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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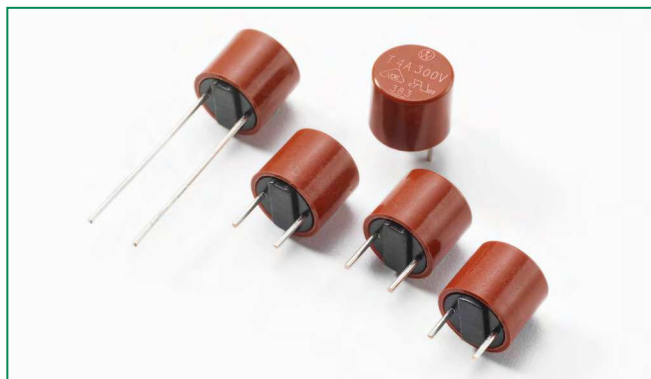
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383 Series, TR5® Time-Lag Fuse



Description

The 383 series are TR5® time-lag 300V rated fuses and designed in accordance to IEC60127-3.

Features

- Halogen free, Lead-free and RoHS compliant
- Reduced PCB space requirements
- Direct solderable or plug-in versions
- Internationally approved
- Low internal resistance
- Shock safe casing
- Vibration resistant

Applications

- Electronic Ballast

Additional Information



Datasheet






Resources



Samples




Agency Approvals

Agency	Agency File Number	Ampere Range
	40022712	4A - 5A
	JET1896-31007-2001 JET1896-31007-1006	1A - 5A 6.3A - 10A
	E67006	1A - 10A

Electrical Characteristics for Series

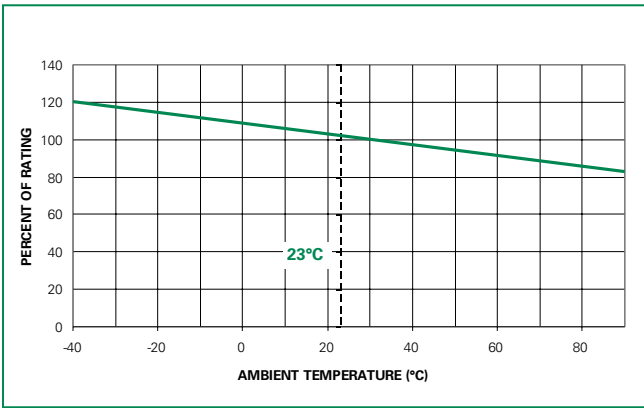
% of Ampere Rating	Opening Time	
	1A - 6.3A	8A - 10A
150%	1 Hour, Min.	1 Hour, Min.
210%	2 Minutes, Max.	300 s, Max.
275%	400 ms, Min. ; 10 s, Max.	1 s, Min. ; 20 s, Max.
400%	150 ms, Min. ; 3 s, Max.	150 ms, Min. ; 3 s, Max.
1000%	20 ms, Min. ; 150 ms, Max.	20 ms, Min. ; 150 ms, Max.

Electrical Characteristics Specifications by Item

Amp Code	Rated Current	Max Voltage Rating	Breaking Capacity	Nominal Cold Resistance (Ohms)	Voltage Drop 1.0xI _N max. (mV)	Power Dissipation 1.5xI _N max. (mW)	Melting Integral 10xI _N max. (A ² s)	Agency Approvals		
										
1100	1.00 A	300 V	100A@300VAC 50A@320VAC	0.0625	100	400	4.85		X	X
1125	1.25 A	300 V		0.0500	95	465	6.88		X	X
1160	1.60 A	300 V		0.0377	90	490	12.67		X	X
1200	2.00 A	300 V		0.0280	85	670	17.80		X	X
1250	2.50 A	300 V		0.0215	80	750	29.69		X	X
1315	3.15 A	300 V		0.0176	75	900	45.35		X	X
1400	4.00 A	300 V		0.0138	70	1200	72.00	X	X	X
1500	5.00 A	300 V	0.0108	65	1250	121.25	X	X	X	
1630	6.30 A	300 V	50A@320VAC 100A@250VAC	0.0076	65	1400	148.84		X	X
1800	8.00 A	300 V		0.0059	63	1600	233.60		X	X
2100	10.00 A	300 V		0.0042	57	1600	365.00		X	X

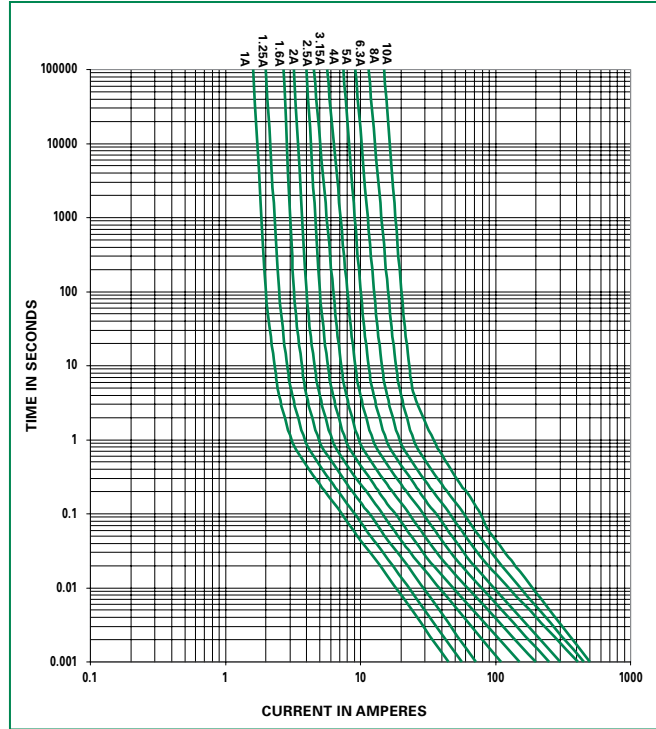
Note: 1.00 means the number one with two decimal places. 1,000 means the number one thousand.

Temperature Re-rating Curve

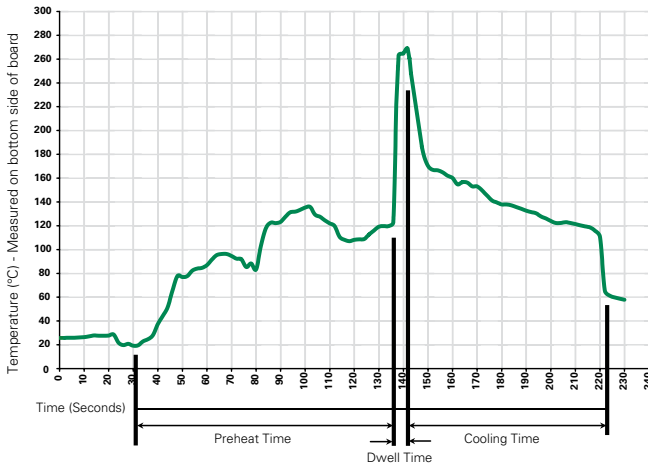


Note:
1. Rerating depicted in this curve is in addition to the standard derating of 25% for continuous operation.

Average Time Current Curves



Soldering Parameters - Wave Soldering



Recommended Process Parameters:

Wave Parameter	Lead-Free Recommendation
Preheat: (Depends on Flux Activation Temperature)	(Typical Industry Recommendation)
Temperature Minimum:	100°C
Temperature Maximum:	150°C
Preheat Time:	60-180 seconds
Solder Pot Temperature:	260°C Maximum
Solder Dwell Time:	2-5 seconds

Recommended Hand-Solder Parameters:

Solder Iron Temperature: 350°C +/- 5°C
Heating Time: 5 seconds max.

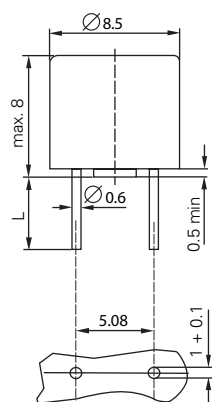
Note: These devices are not recommended for IR or Convection Reflow process.

Product Characteristics

Materials	Base/Cap: Brown Thermoplastic Polyamide PA 6.6, UL 94 V-0 Round Pins: Copper, Tin-plated
Lead Pull Strength	10 N (IEC 60068-2-21)
Solderability	260°C, ≤ 3s. (Wave) 350°C, ≤ 1s. (Soldering Iron)
Soldering Heat Resistance	260°C, 10s. (IEC 60068-2-20) 350°C, 3s. (Soldering Iron)

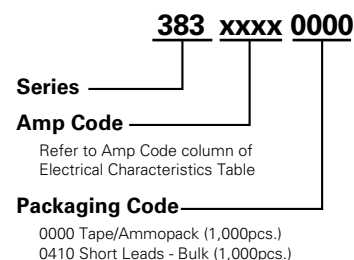
Operating Temperature	-40°C to +85°C (consider re-rating)
Climatic Category	-40°C to +85°C /21 days (IEC 60068-1,-2-1,-2-2,-2-78)
Stock Conditions	+10°C to +60°C RH ≤ 75% yearly average, without dew, maximum value for 30 days-95%
Vibration Resistance	24 cycles at 15 min. each (IEC 60068-2-6) 10 - 60 Hz at 0.75 mm amplitude 60 - 2000 Hz at 10 g acceleration

Dimensions



Holes in PCB
 Long Leads (L=18.8mm)
 Short Leads (L=4.3mm)

Part Numbering System



Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code	Taping Width
383 Series				
Tape & Ammopack	N/A	1,000	0000	N/A
Short Leads	N/A	1,000	0410	N/A